AGC Amplifier

FEATURES

- **Low-Distortion AGC Amplifier**
- **Wide Gain-Control Range**
- **5-V Power Supply**
- **8-Pin MSOP Package**

APPLICATIONS

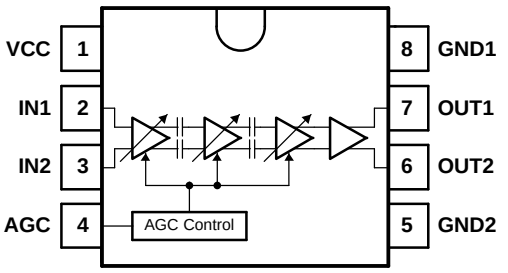
- **Digital TV**
- **Digital CATV, STB**

DESCRIPTION

The SN761663 is an AGC amplifier for the TV tuner system of a digital TV, CATV, or STB. The circuit consists of three stages of controlled-gain amplification, followed by a fixed-gain output amplifier.

The device is packaged in an 8-pin MSOP suitable for surface mounting.

DGK PACKAGE
(TOP VIEW)



P0026-03

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) (1)

	SN761663
Supply voltage, V_{CC} (pin 1)(2)	–0.4 V to 6.5 V
Input voltage(2), AGC (pin 4), IN1 (pin 2), IN2 (pin 3)	–0.4 V to V_{CC}
Continuous total dissipation	477 mW (3)
Operating free-air temperature, T_A	–20°C to 85°C
Junction temperature, T_J	150°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) Voltage values are with respect to the GND of the circuit.
(3) At $T_A \leq 25°C$. For $T_A > 25°C$, the derating factor is 3.82 mW/°C.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.5	5	5.5	V
T_A	Operating free-air temperature	–20		85	°C

DC ELECTRICAL CHARACTERISTICS

V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{CC}	Supply current			23		mA
I_{IAGC}	Input current (AGC)	V_{AGC} = 3 V		30	60	µA
V_{AGCMAX}	AGC maximum gain control voltage	Maximum gain	3		V_{CC}	V
V_{AGCMIN}	AGC minimum gain control voltage	Minimum gain	0		1	V

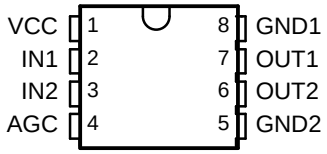
AC ELECTRICAL CHARACTERISTICS

V_{CC} = 5 V, T_A = 25°C. Parameters measured in test circuit of Figure 9 or Figure 10.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
G_{MAX}	Maximum gain	V_{AGC} = 3 V	56	60	64	dB
G_{MIN}	Minimum gain	V_{AGC} = 0 V	–10	–7	–4	dB
GCR	Gain control range	V_{AGC} = 0 V–3 V		67		dB
V_{OUT}	Output voltage	Single-ended output		2.6		Vp-p
NF	Noise figure	Maximum gain		10		dB
IM3	Third-order intermodulation distortion	f_{IN1} = 43 MHz, f_{IN2} = 44 MHz, V_{OUT} = –2 dBm, maximum gain		–50		dBc
IIP3	Input intercept point	Minimum gain		11		dBm
R_{IN}	Input resistance (IN1, IN2)			1		kΩ

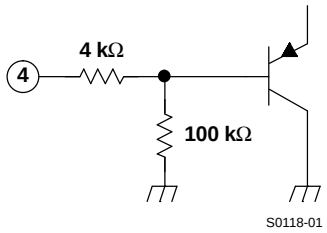
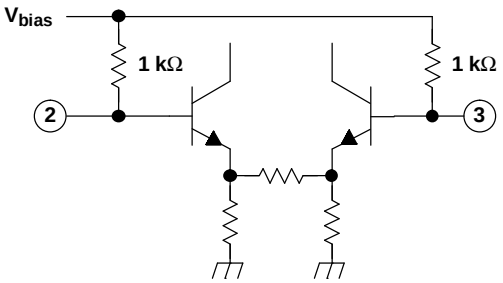
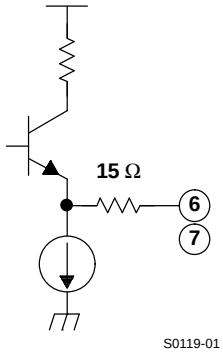
DEVICE INFORMATION

DGK PACKAGE
(TOP VIEW)



P0026-02

TERMINAL FUNCTIONS

TERMINAL		I/O	EQUIVALENT CIRCUIT	DESCRIPTION
NAME	NO.			
AGC	4	I	 S0118-01	Gain-control voltage
GND1	8	–		Ground
GND2	5	–		Ground
IN1	2	I	 S0117-01	AGC amplifier input
IN2	3	I		AGC amplifier input
OUT1	7	O	 S0119-01	AGC amplifier output
OUT2	6	O		AGC amplifier output
V_{CC}	1	–		5-V power supply

TYPICAL CHARACTERISTICS

GAIN
vs
VAGC

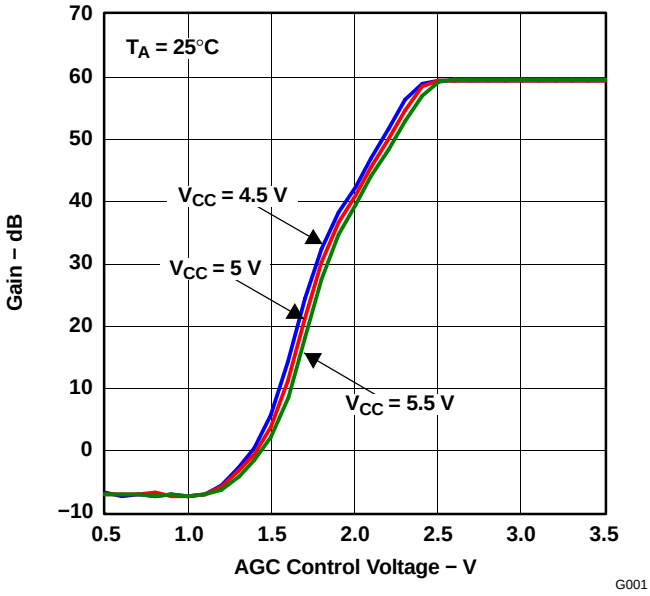


Figure 1.

NOISE FIGURE
vs
GAIN

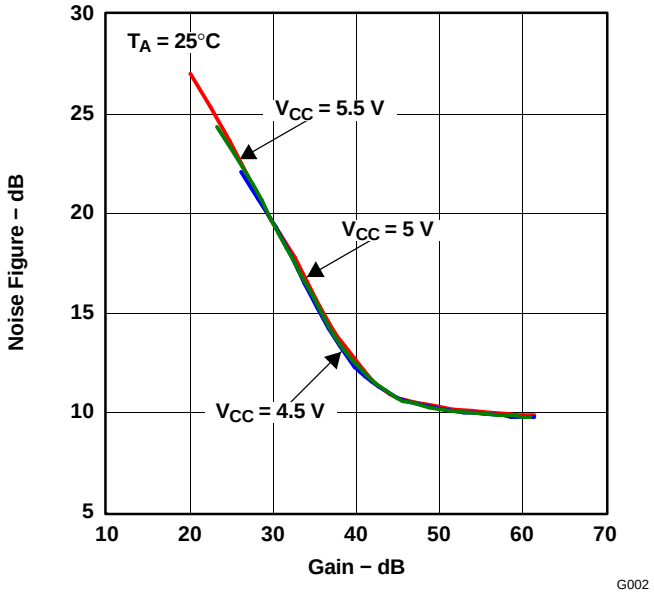


Figure 2.

OUTPUT LEVEL
vs
INPUT LEVEL

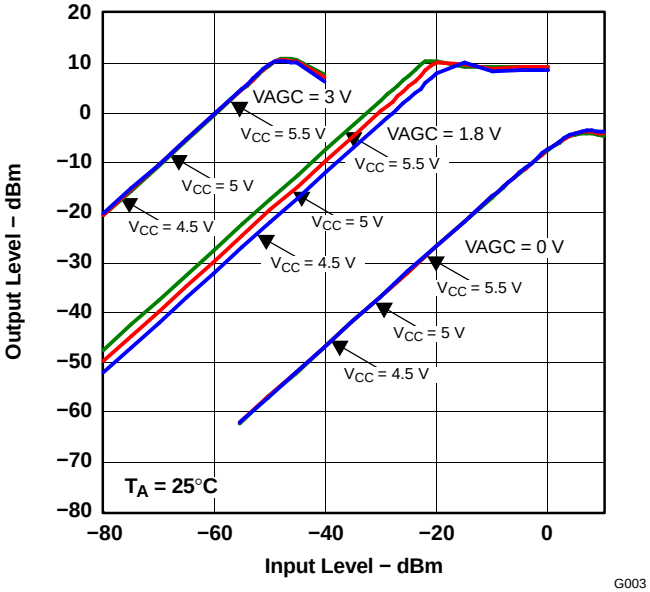


Figure 3.

GAIN
vs
FREQUENCY

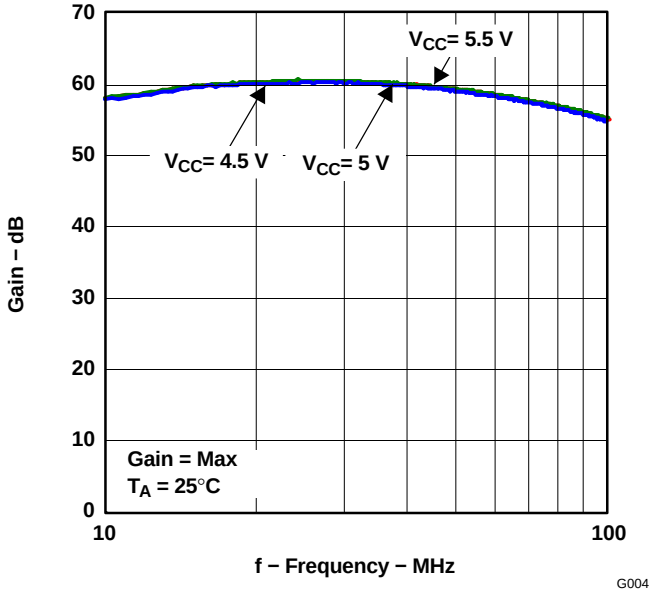


Figure 4.

TYPICAL CHARACTERISTICS (continued)

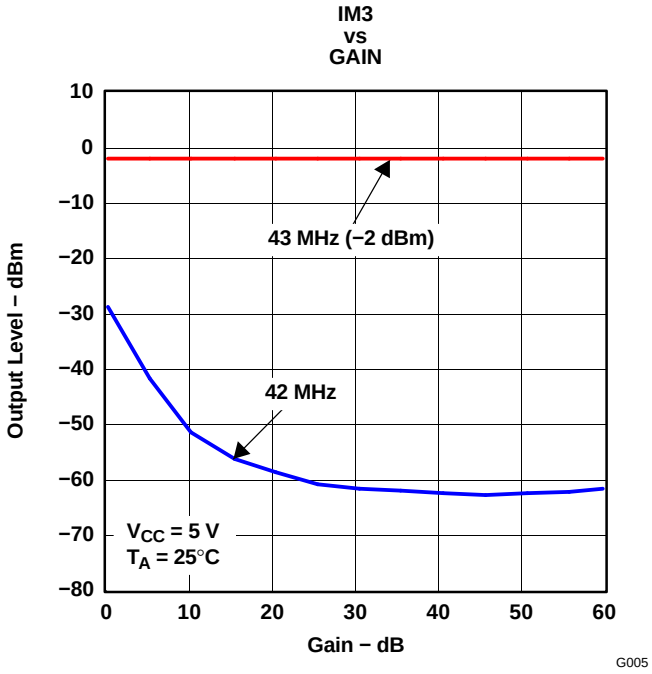


Figure 5.

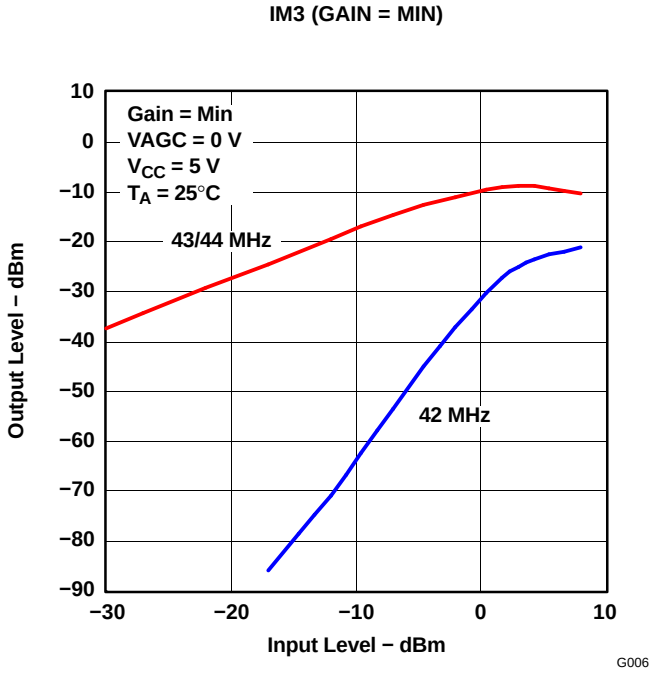


Figure 6.

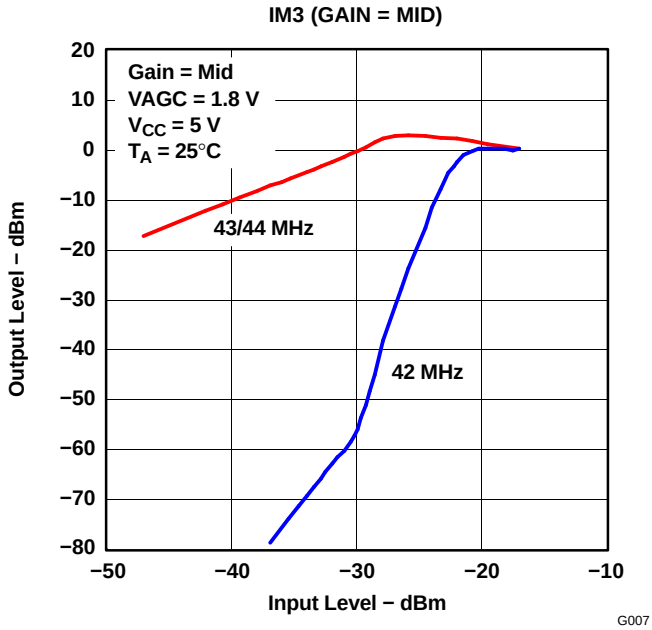


Figure 7.

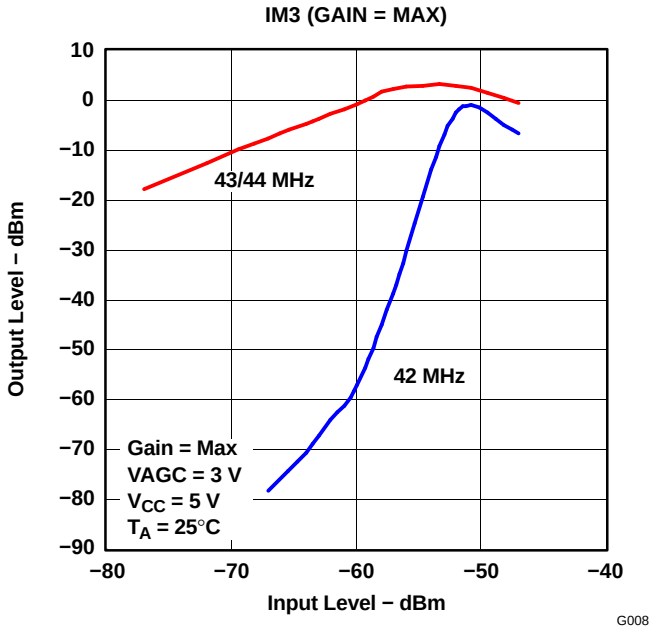


Figure 8.

APPLICATION INFORMATION

TEST CIRCUITS

Figure 9 and Figure 10 are test circuits for the SN761663. Figure 9 is the circuit for measurement of gain and output voltage. Figure 10 is the circuit for measurement of intermodulation distortion and input intercept point. This application information is advisory, and a performance check is required for actual application circuits.

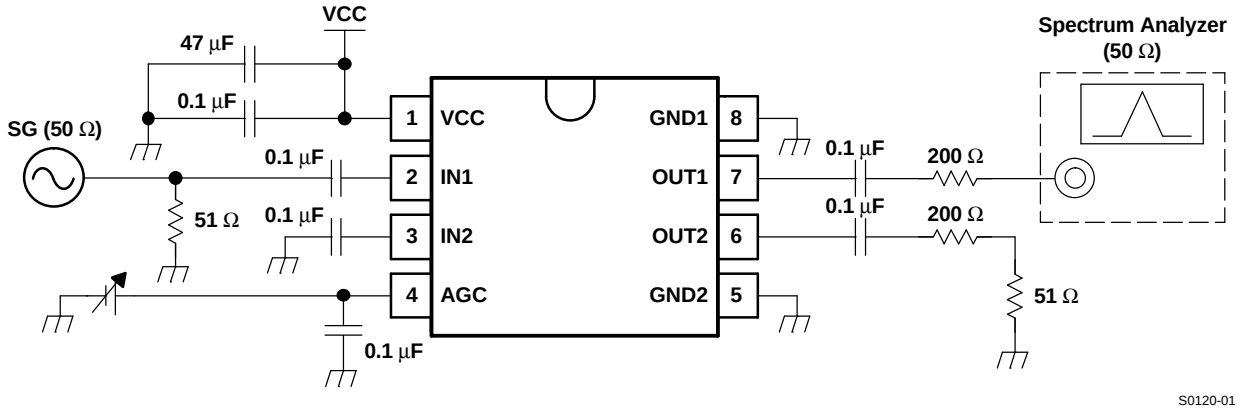


Figure 9. Measurement Circuit for Gain and Output Voltage

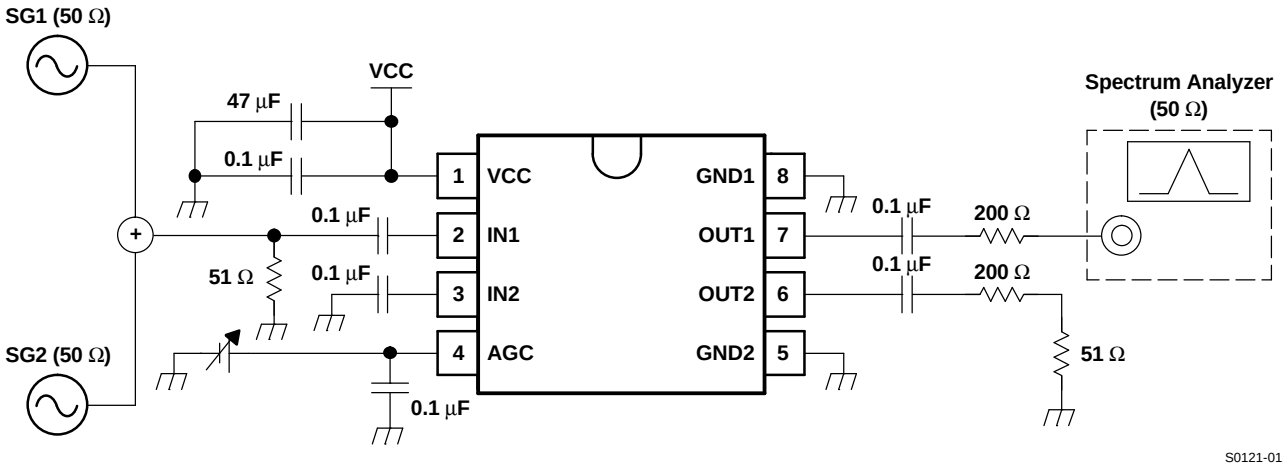


Figure 10. Measurement Circuit for IM3 and IIP3

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN761663DGK	OBSOLETE	VSSOP	DGK	8		TBD	Call TI	Call TI	-20 to 85	BPA	
SN761663DGKG4	OBSOLETE	VSSOP	DGK	8		TBD	Call TI	Call TI	-20 to 85		
SN761663DGKR	OBSOLETE	VSSOP	DGK	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-20 to 85	BPA	
SN761663DGKRG4	OBSOLETE	VSSOP	DGK	8		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-20 to 85	BPA	

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

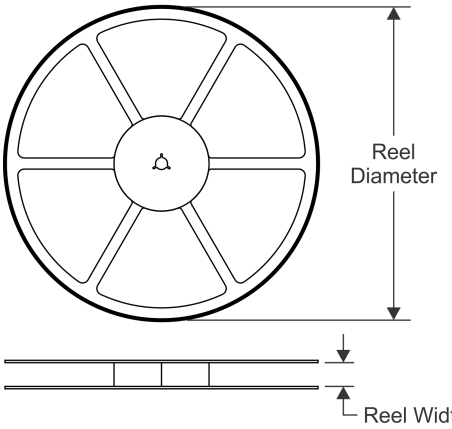
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

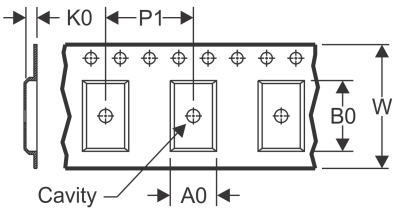
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

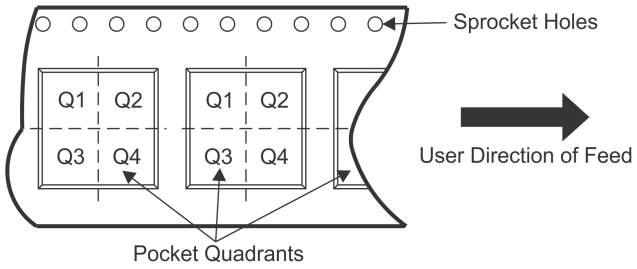


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

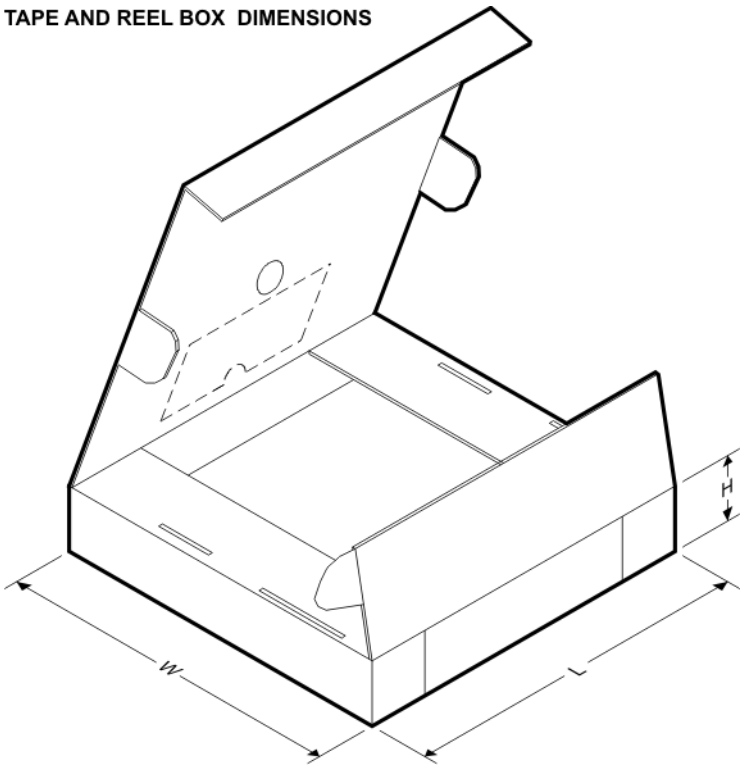
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN761663DGKR	VSSOP	DGK	8	0	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1

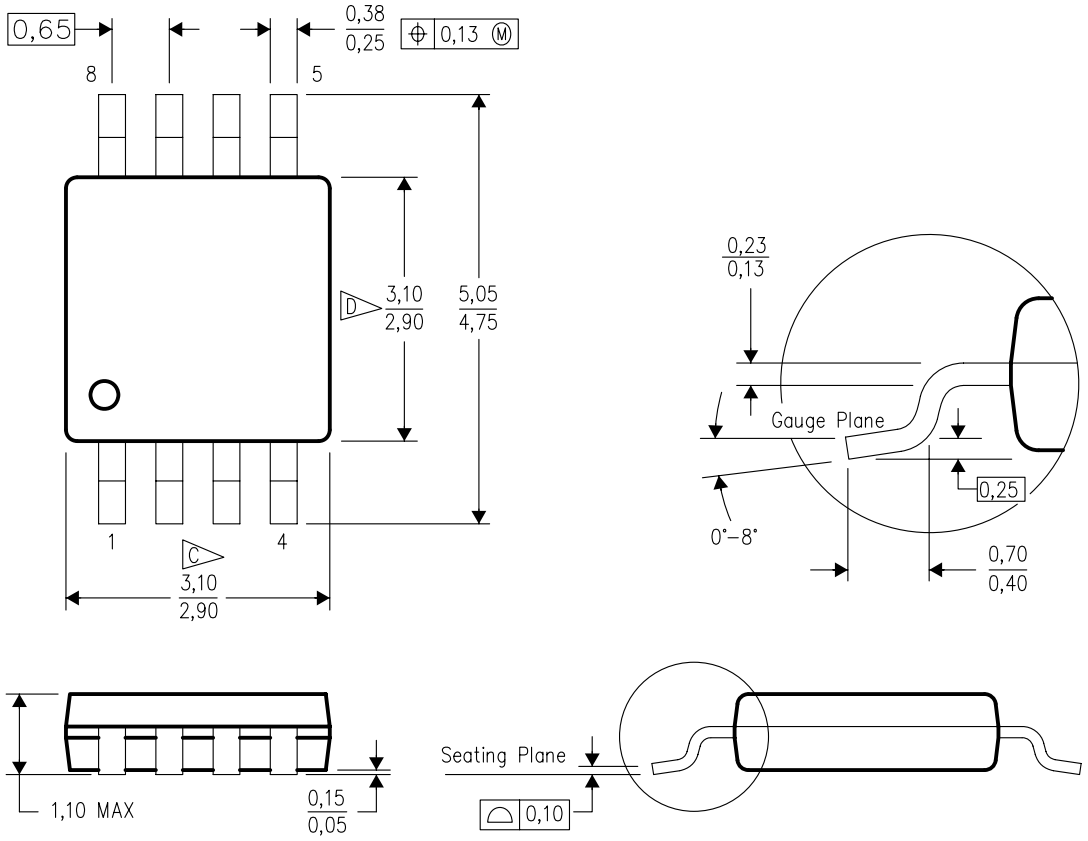
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN761663DGKR	VSSOP	DGK	8	0	367.0	367.0	35.0

DGK (S–PDSO–G8) PLASTIC SMALL–OUTLINE PACKAGE



4073329/E 05/06

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
E. Falls within JEDEC MO–187 variation AA, except interlead flash.

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